

HSE

NOTES:

Current Rating: 2.0AMP

Contact Resistance: 20m Ω Max

Withstand Voltage: 500V AC/DC

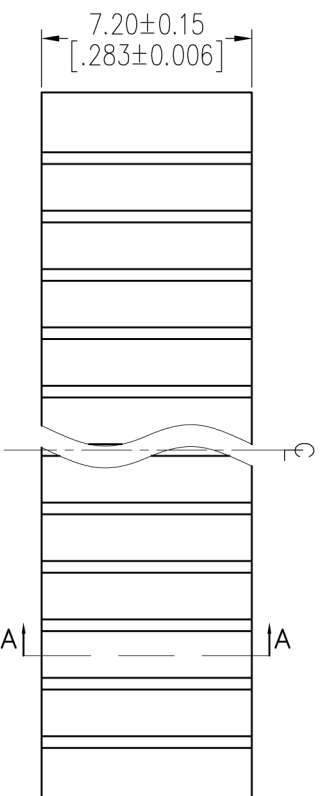
Insulation Resistance: 1000M Ω Min

Operation Temperature: -40°C to $+105^{\circ}\text{C}$

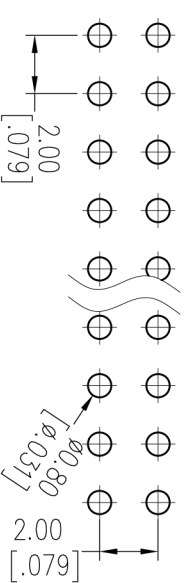
Contact Material: Phosphor Bronze

Contact plating: Au Or Sn over Ni

Insulator Material: PA9T+30%G.F UL94V-0



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE $\pm$ 0.05)



Ordering Information

2272 - 2 XX R XX CUNT I

No.of Pins per
ROW:02~40PIN

Contact Plating:
G0=Gold Flash

Packing:
T=Tube

T=Tube

CONTRIBUTOR'S ADDRESS:

Gr3=10.11"Grold

G4=15μ"Gold

 $G5=30\mu''\text{Gold}$

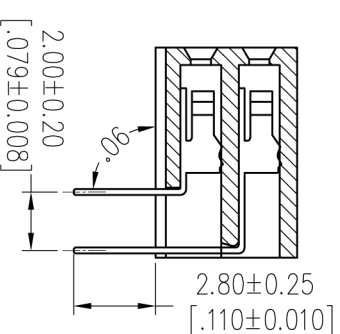
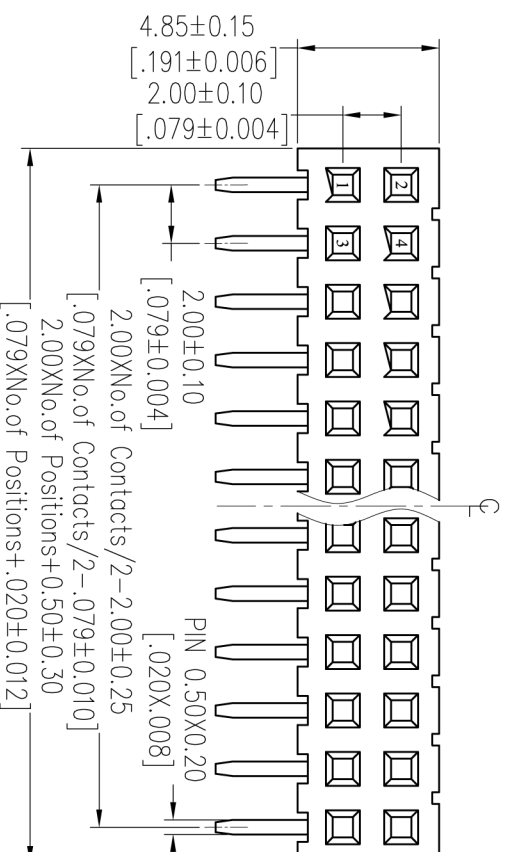
S0=Gold Flash/Tin

S3=10 μ "Gold/Tin

S4=15μ"Gold/Tin

 $SS=30\mu\text{m}^2\text{Gold}/1\text{m}$ $SN=1$ in

SM=Matte Tin



SECTION A-A

Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

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